

Technical Specification for Optical Transceiver Module

SDM7111-XC

SDM7111-GC

- | | | |
|--|---|--|
| <input checked="" type="checkbox"/> 155.52Mb/s | <input type="checkbox"/> 622.08Mb/s | <input type="checkbox"/> other _____ |
| <input type="checkbox"/> Short Haul | <input checked="" type="checkbox"/> Long Haul | <input type="checkbox"/> other _____ |
| <input type="checkbox"/> Intermediate Reach | <input checked="" type="checkbox"/> Long Reach | <input type="checkbox"/> other _____ |
| <input checked="" type="checkbox"/> Single 5.0 V | <input type="checkbox"/> Single 3.3 V | <input type="checkbox"/> other _____ |
| <input checked="" type="checkbox"/> 1.3 μ m | <input type="checkbox"/> 1.55 μ m | <input type="checkbox"/> other _____ |
| <input type="checkbox"/> Transmitter | <input type="checkbox"/> Receiver | <input checked="" type="checkbox"/> Transceiver |
| | (<input type="checkbox"/> 2R / <input type="checkbox"/> 3R) | (<input checked="" type="checkbox"/> 2R / <input type="checkbox"/> 3R) |



Sumitomo Electric reserves the right to make changes in this specification without prior notice.

#Safety Precaution Symbols This specification uses various picture symbols to prevent possible injury to operator or other persons or damage to properties for appropriate use of the product. The symbols and definitions are as shown below. Be sure to be familiar with these symbols before reading this specification.

	Warning	Wrong operation without following this instruction may lead to human death or serious injury.
	Caution	Wrong operation without following this instruction may lead to human injury or property damage.

Example of picture symbols



indicates prohibition of actions. Action details are explained thereafter.



indicates compulsory actions or instructions. Action details are explained thereafter.

(SDM7111-XC, SDM7111-GC)

SDM7111-XC is a series of compact and high speed performance digital optical transceiver module ideally designed for versatile high speed network applications. 1300nm high speed InGaAsP DFB-LD and InGaAs PIN-PD are provided as a light source and a detector, respectively. Transceiver module has PC board mountable package with electrical and optical interfaces.

* Data Rate	10 ~ 155.52Mbps, NRZ
* Duty Cycle	50%
* Power Supply Voltage	Single +5.0V
* Electrical Interface	PECL
* Fiber Coupled Power	-5dBm for SMF
* Sensitivity	~ -34dBm
* Connector Interface	SC Duplex Connector

*Features

- Low Power Consumption
- Low Profile (9.8mm Max) Plastic Molded Package
- Multi-sourced Footprint

Transmitter.....	Uncooled Laser with Automatic Power Control IC Class 1 Laser Product (IEC 825-1 and FDA 21 CFR 1040.10 and 1040.11)
Receiver.....	Wide Dynamic Range Signal Detect (FLAG) Function

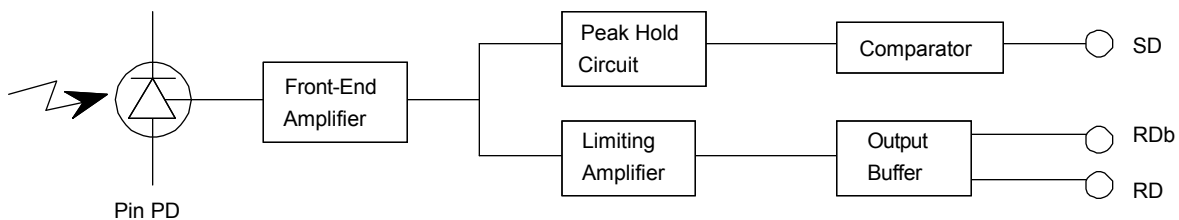
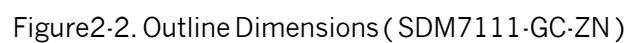
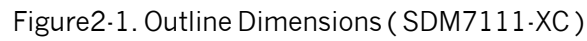


Figure 1-2. Block Diagram(Receiver)

All dimensions are in mm.



1. Surface of the receptacle and latch levers are metalized.

All dimensions are in mm.

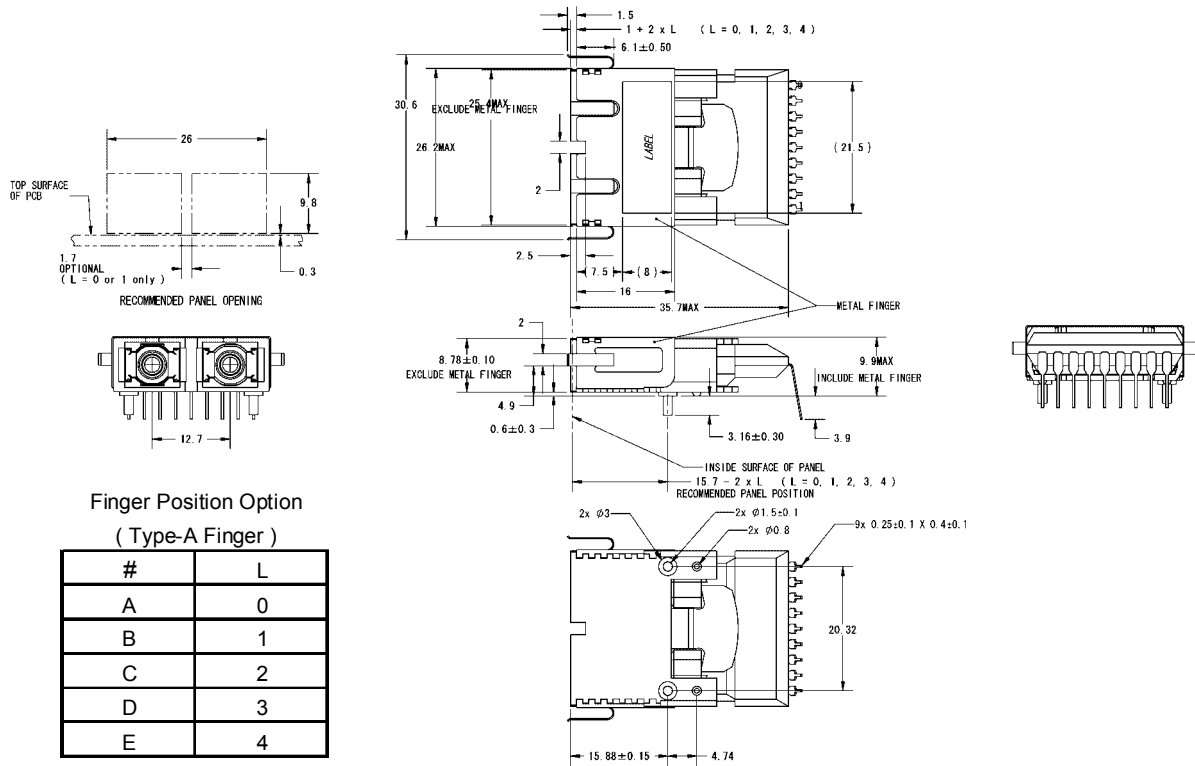


Figure2-3. Outline Dimensions (SDM7111-GC-#N)

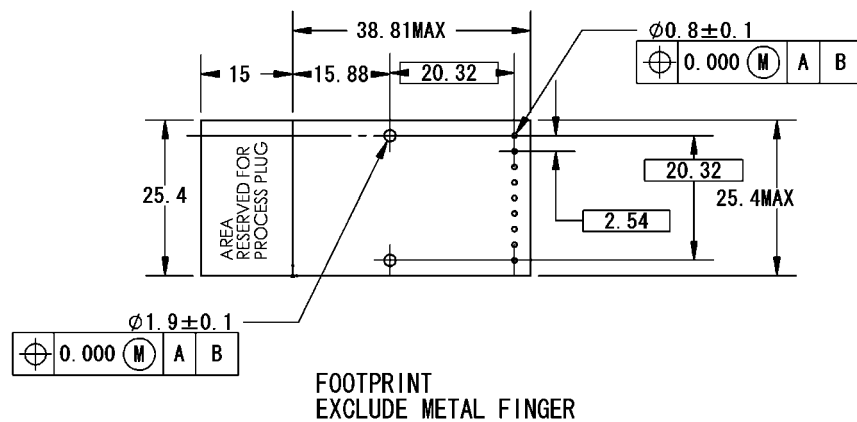


Figure2-4.RecommendedFootprint

⚠ Caution



Do not disassemble this product. Otherwise, failure, electrical shock, overheating or fire may occur.
Handle the lead pins carefully. Use assisting tools or prospective aids as required. A lead pin may injure skin or human body

4. Pin Assignment


No.	Symbol	Function
1	Veerx	Power Supply (-) for Receiver : Connected to GND
2	RD	Differential Data Output (Positive)
3	RDb	Differential Data Output (Negative)
4	FLAG(SD)	FLAG (Signal Detect)
5	Vccrx	Power Supply (+) for Receiver : Connected to +5.0V
6	Vcctx	Power Supply (+) for Transmitter : Connected to +5.0V
7	TDb	Transmitter Differential Data (Negative)
8	TD	Transmitter Differential Data (Positive)
9	Veetx	Power Supply (-) for Transmitter : Connected to GND

5. Absolute Maximum Ratings


Parameter	Symbol	min.	Max	Unit	Note
Storage Case Temperature	Ts	-40	85	°C	1
Operating Case Temperature	Tc	0	70	°C	1
Supply Voltage	Vcc-Vee	0.0	6.0	V	2
Input Voltage (TD, TDb)	Vi	0.0	Vcc	V	
Output Voltage (RD, RDb, SD)	Io		30	mA	
Lead Soldering (Temperature)	Ltemp		260	°C	3
Lead Soldering (Time)	Ltime		10	sec.	3

Note 1. No condensation allowed. 2. Vcc>Vee, Vcc=+5.0V, Vee=GND
3. Measured on lead pin at 2mm (0.079in.) off the package bottom

Warning

 Use the product with the rated voltage described in the specification. If the voltage exceeds the maximum rating, overheating or fire may occur.

Caution

 Do not store the product in the area where temperature exceeds the maximum rating, where there is too much moisture or dampness, where there is acid gas or corrosive gas, or other extreme conditions. Otherwise, failure, overheating or fire may occur.

6. Electrical Interface

(Unless otherwise specified, $V_{cc}-V_{ee} = 4.75$ to 5.25 V and all operating temperature shall apply.)

6-1. Transmitter side

Parameter	Symbol	min.	Typ.	Max.	Unit	Note
Supply Voltage	$V_{cc}-V_{ee}$	4.75	5.00	5.25	V	
Supply Current	I_{dtx}		70	180	mA	1
Input Voltage TD, TDb	High	V_{ih}	$V_{cc}-1.17$	$V_{cc}-0.73$	V	2
	Low	V_{il}	$V_{cc}-1.95$	$V_{cc}-1.45$		
Input Current TD, TDb	High	I_{ih}	-10	150	μA	2
	Low	I_{il}	-10	10		
Signal Input Rise / Fall Time	T_{rin}, T_{fin}			0.5	nsec.	3

Note 1. Input bias current is not included. 50% duty cycle data. 155.52Mbps 2. $V_{cc}-V_{ee}=5.0V$, $T_c=25^\circ C$ 3. 20 ~ 80%

6-2. Receiver side

Parameter	Symbol	min.	Typ.	Max.	Unit	Note
Supply Voltage	$V_{cc}-V_{ee}$	4.75	5.00	5.25	V	
Supply Current	I_{drx}		60	110	mA	1
Data & SD Output Voltage	High	V_{oh}	$V_{cc}-1.03$	$V_{cc}-0.88$	V	2
	Low	V_{ol}	$V_{cc}-1.81$	$V_{cc}-1.62$		
Data Rise / Fall Time of Output Signal	T_{rout}, T_{fout}			1.6	nsec	3

Note 1. Output current is not included.

2. $V_{ccrx}=+5.0V$, $T_c=25^\circ C$, Output load resistance

$R_L=50\Omega$ to $V_{ccrx}-2V$ for RD, RDb and SD.

3. 20 ~ 80%

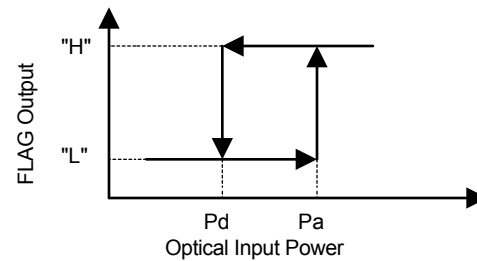


Figure 4. FLAG Assert Level and Deassert Level

7. Optical Interface

(Unless otherwise specified, $V_{cc}-V_{ee} = 4.75$ to 5.25 V and all operating temperature shall apply.)

7-1. Transmitter side

Parameter	Symbol	min.	Typ.	Max.	Unit	Note
Average Output Power to SMF	P_{os}	-5.0		0.0	dBm	1
Extinction Ratio	E_r	10.0			dB	1
Center Wavelength	λ_c	1280		1335	nm	
Spectral Width (RMS)	$\Delta\lambda$			4.0	nm	
Eye Mask for Optical Output	Refer to Figure 5					

Note 1. Measured at 155.52Mbps PRBS2²³-1, 50% duty cycle data

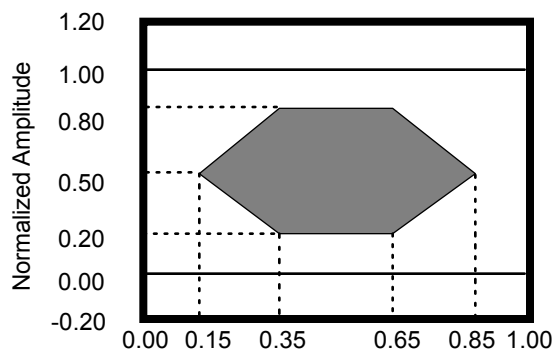


Figure 5. Optical Pulse Mask with Fourth Order Bessel-Thomson Filter Specified in ITU-T G.957

Relation between Input Signal and Optical Output Signal

Input Signal		Optical Output Signal
TD	TDb	
High	Low	ON (High)
Low	High	OFF (Low)
High	High	Undefined
Low	Low	Undefined

⚠ Warning



Do not look at the laser beam projection area (e.g. end of optical connector) with naked eyes or through optical equipment while the power is supplied to this product. Otherwise, your eyes may be injured.

7-2. Receiver side

Parameter	Symbol	min.	Typ.	Max.	Unit	Note
Average Input Power to SMF	Pin	-34.0		-8.0	dBm	1, 2
Flag Assert Level	Pa	-48.0	-36.0	-34.0	dBm	2
Flag deassert Level	Pd	-49.0	-39.0	-34.0	dBm	2
Flag Assert Time	Tsda			100	μsec	2, 3
Flag deassert Time	Tsdd			350	μsec	2, 3

Note 1. BER=10⁻¹⁰, 2. Measured at the bit rate of 155.52Mbps, PRBS 2²³-1, NRZ

3. 50% duty cycle data

8. Recommended Interface Circuit

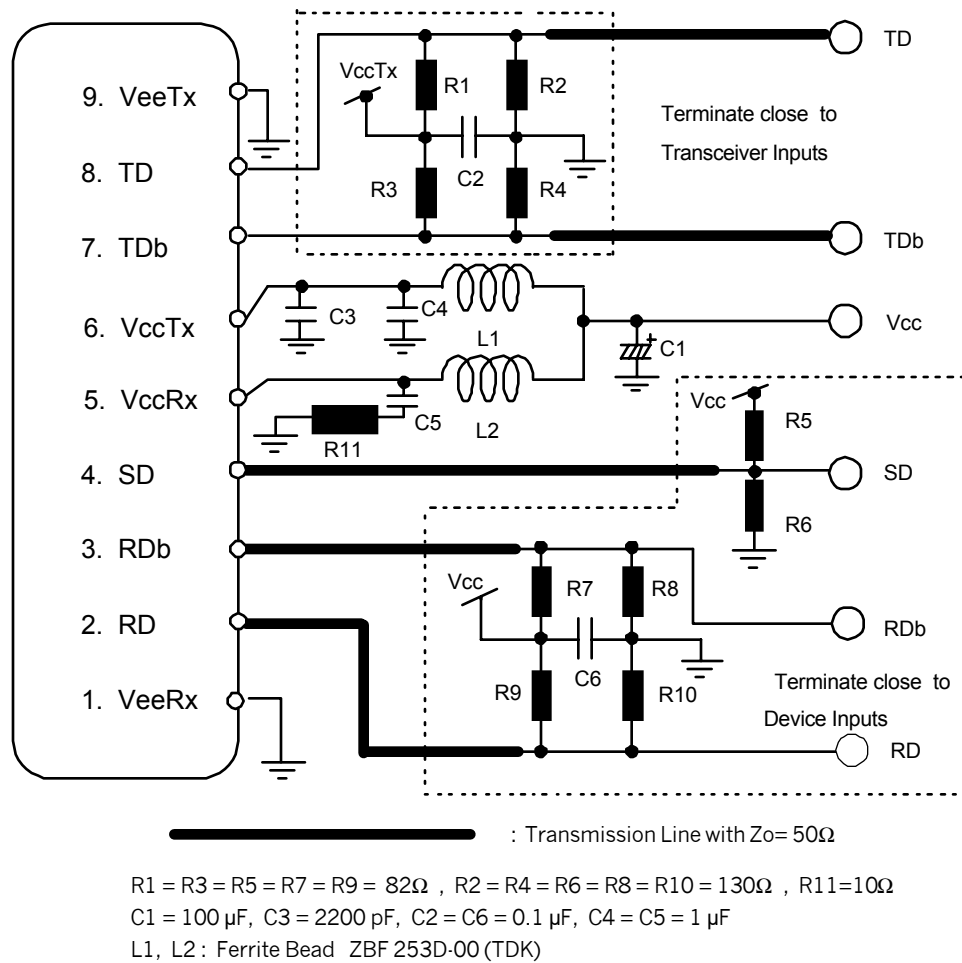


Figure 6 Recommended Interface Circuit

9. Reliability Test

Bellcore TA-NWT-000983 Issue 2, December 1993								
Heading	Test	Reference	Condition	Sampling			SEI Plan	
				LTPD	SS	C	SS	F/C
Mechanical Integrity	Mechanical Shock	MIL-STD-883 Method 2002	Condition B					
			5 times/axis					
			500G, 1.0 ms	20%	11	0	---	---
	Vibration	MIL-STD-883 Method 2007	1,500G, 0.5ms	20%	11	0	11	0
			Condition A	20%	11	0	11	0
			20 G					
	Thermal Shock	MIL-STD-883 Method 1011	20-2,000 Hz					
4 min/cycle; 4 cycles/axis								
Endurance	Accel. Aging (High Temp.)	(R)-453 Section 5.18	ΔT=100°C	20%	11	0	11	0
			(steam aging not required)	20%	11	0	11	0
	Solderability	MIL-STD-883 Method 2003						
	Fiber Pull							
Endurance	Accel. Aging (High Temp.)	(R)-453 Section 5.18	1 Kg; 3 times;5sec.	20%	11	0	---	---
			2 Kg; 3 times; 5sec.	20%	11	0	---	---
	High Temp. Storage	-----	+85C; rated power					
			>5,000hrs.	---	25	---	25	0
	High Temp. Storage	-----	>10,000hrs.	---	10	---	---	---
			max. storage T (T=85°C)	20%	11	0	---	---
	Low Temp. Storage	-----	>2,000					
			min. storage T (T=-40°C)	20%	11	0	11	0
	Temperature Cycling	Section 5.20	>2,000					
			- 40°C to +85°C					
			400 times pass/fail	20%	11	0	---	---
			500 times for info.	---	11	---	---	---
Damp Heat (if using epoxy)	MIL-STD-202 M103 or IEC 68-2-3	500 times pass/fail	20%	11	0	11	0	
		1000 times for info.	---	11	---	11	0	
		40°C , 95%, 56days	20%	11	0	11	0	
		or 85°C /85%RH 2,000hrs	20%	11	0	---	---	
Cyclic Moisture Resistance	Section 5.23		20%	11	0	11	0	
Special Tests	Internal Moisture	MIL-STD-883 Method 1018		20%	11	0	11	0
	Flammability	TR357:Sec. 4.4.2.5	< 5,000 ppm water vapor					
	ESD Threshold	Section 5.22						

10. Laser Safety

This product uses a semiconductor laser system and is a laser class 1 product acc. FDA, complies with 21CFR1040. 10 and 1040.11. Also this product is a laser class 1 product acc. IEC 825-1.

Class 1 Laser Product

⚠ Caution



If this product is used under conditions not recommended in the specification or this product is used with unauthorized revision, classification for laser product safety standard is invalid. Classify the product again at your responsibility and take appropriate actions.

11. Other Precaution

Under such a strong vibration environment as in automobile, the performance and reliability are not guaranteed.

The governmental approval is required to export this product to other countries. To dispose of these components, the appropriate procedure should be taken to prevent illegal exportation.

This module must be handled, used and disposed of according to your company's safe working practice.

⚠ Warning	
❗	Be sure to carry out correct soldering for connection to peripheral circuits in order to prevent contact failure or short-circuit. Otherwise, a strong laser beam may cause eye injury, overheating or fire.
🚫	Do not put this product or components of this product into your mouth. This product contains material harmful to health.

⚠ Caution	
❗	Be sure to turn the power off when you touch this product connected to the printed circuit boards. Otherwise, electric shock may occur.
🚫	Dispose this product or equipment including this product properly as an industrial waste according to the regulations.

12. Ordering Information

Ordering Number	Connector type	Operating Temperature
SCM7111-XC	SC Duplex Connector, Non-metallized.	-5 ~ 70°C
SCM7111-GC-#N	SC Duplex Connector, Metallized. See chart below for detail.	

SDM7111-GC-# N

EMI Shield Finger Option

Z : Without Finger

A ~ E : With Type-A Finger

*Letter specifies finger position.

Refer to Figure 2-3 for detail.

13. For More Information

U.S.A.

ExcelLight Communications, 4021 Stirrup Creek Drive, Suite 200 Durham, NC 27703

Tel. +1-919-361-1600 / Fax. +1-919-361-1619

E-mail: info@excelight.com

<http://www.excelight.com>

Europe

Sumitomo Electric Europe Ltd., 220, Centennial Park, Elstree, Herts, WD6 3SL, United Kingdom

Tel. +44-208-953-8681

Fax. +44-208-207-5950

<http://www.sumielectric.com>

Japan

Sumitomo Electric Industries, Ltd. (International Business Division), 3-12, Moto-Akasaka 1-chome

Minato-ku Tokyo 107-8468

Tel. +81-3-3423-5771 / Fax. +81-3-3423-5099

E-mail: product-info@ppd.sei.co.jp

<http://www.sei.co.jp/Electro-optic/index.html>

(SDM7111-XC, SDM7111-GC)